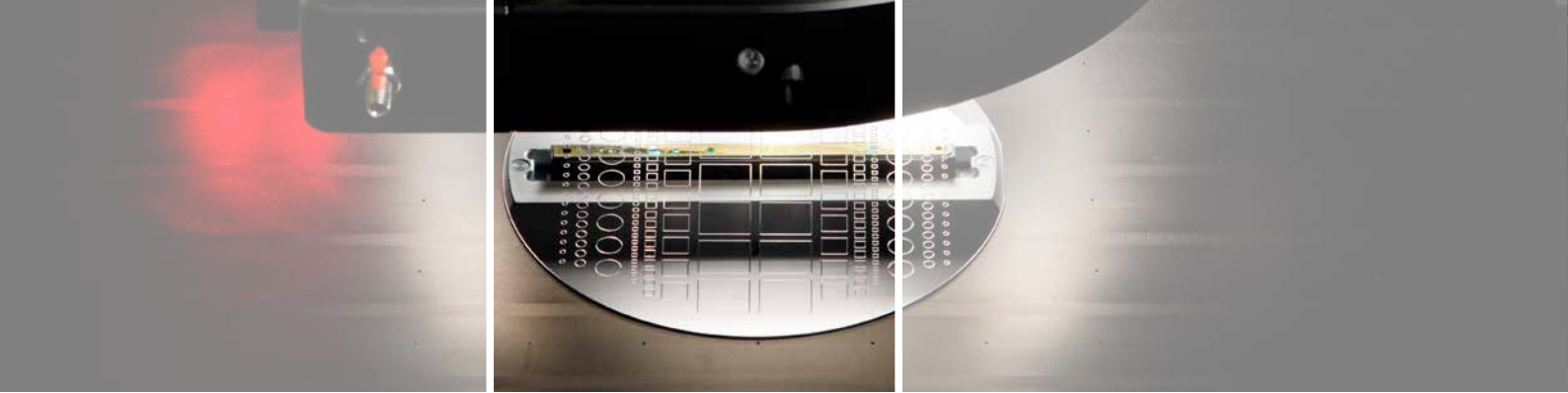


INKJET PRINTER

••PiXDRO LP50

ADVANCED DESKTOP R&D INKJET PRINTER



INKJET PRINTER

PiXDRO LP50

VERSATILE PRINTER FOR A LARGE VARIETY OF PROCESSES

The PiXDRO LP50 is a desktop R&D inkjet printer for functional printing applications. It is designed for research and development of inkjet processes and applications, as well as evaluation and development of inkjet materials. The LP50 platform is an open, accurate, flexible, and easy to use system that will allow you to work at the frontiers of inkjet printing technology. The LP50 is designed for a wide range of applications such as semiconductor packaging, PCB, printed electronics, photo voltaic, display, and bio-medical.

With its PiXDRO brand, SÜSS MicroTec is the world leader in inkjet printing for electronics applications. Many applications are under development at R&D centers using the PiXDRO LP50 R&D inkjet printer, and several have matured to a level where production sites adopt inkjet printing as a fully industrial production technology.

Inkjet printing is a very versatile technology. It can be used for direct material deposition for patterned or homogeneous coatings, from tens of nanometers up to tens of micrometers. By printing multiple layers of material on top of each other, it can also be used as a 3D printing method.

Inkjet is a non-contact deposition technology, so suitable for fragile and 3D substrates, and can fill trenches and cavities. Furthermore, it is excellent for direct printing of etching and plating masks.

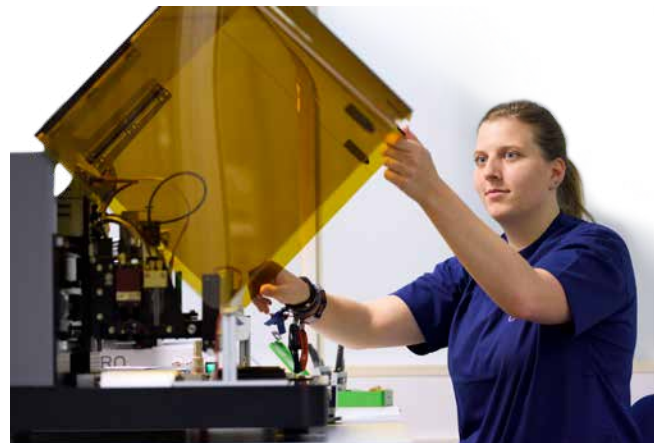
SÜSS MicroTec offers the PiXDRO industrial inkjet printing equipment to apply a wealth of functional materials. These functional materials can have dielectric, conductive, adhesive, mechanical, optical or chemical properties, and are printed with pico-liter sized droplets from a digital file.

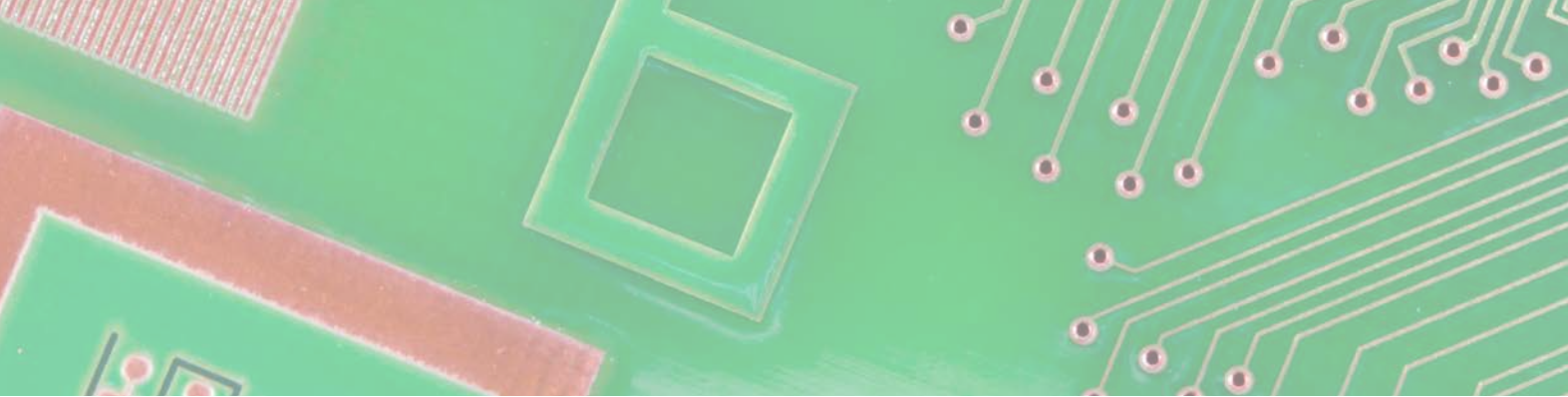
Inkjet printing is an additive manufacturing technology, hence has great advantages in relation to material usage, productivity, environmental impact and costs. It can create very fine features, down to 20 micron, and can replace conventional techniques such as lithography, screen printing, spray coating and dispensing. Because it is fully digital, there is no need for masks and screens, significantly saving material usage, and enabling fast product change-over times.



PiXDRO LP50 HIGHLIGHTS

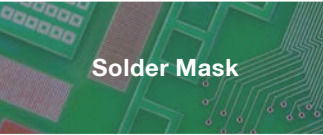

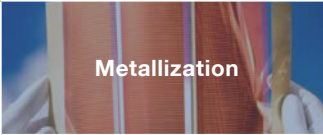

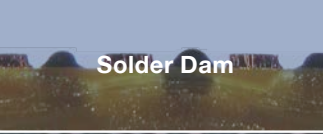



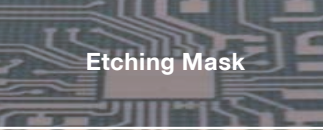

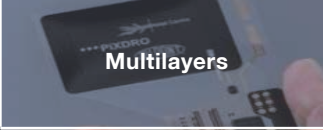
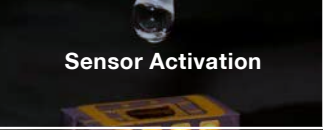
- + Flexible, robust and accurate R&D inkjet printer
- + Choice of industrial printheads
- + Advanced software metrology packages
- + Integrated drop and print vision systems
- + Printhead maintenance station
- + Large variety of optional features





ENABLING FUTURE TECHNOLOGIES

INKJET APPLICATION EXAMPLES

Printed Circuit Board (PCB)	Semiconductor	Printed Electronics (PE)	Others
 Solder Mask	 Passivation	 Metallization	 Pharma
 Solder Dam	 Photo Resist	 Encapsulation	 Micro Etching
 Etching Mask	 Leadframe Coating	 Multilayers	 Sensor Activation

MAIN FEATURES

Choice of Printheads

- + Konica Minolta, Xaar, Fujifilm Dimatix, Canon
- + For wide range of applications

Accurate Motion Platform

- + 5 axis movement
- + Precise substrate alignment

Printhead Maintenance

- + Wiping, purging and capping
- + Drop view and fast nozzle scanning



Advanced Metrology Software

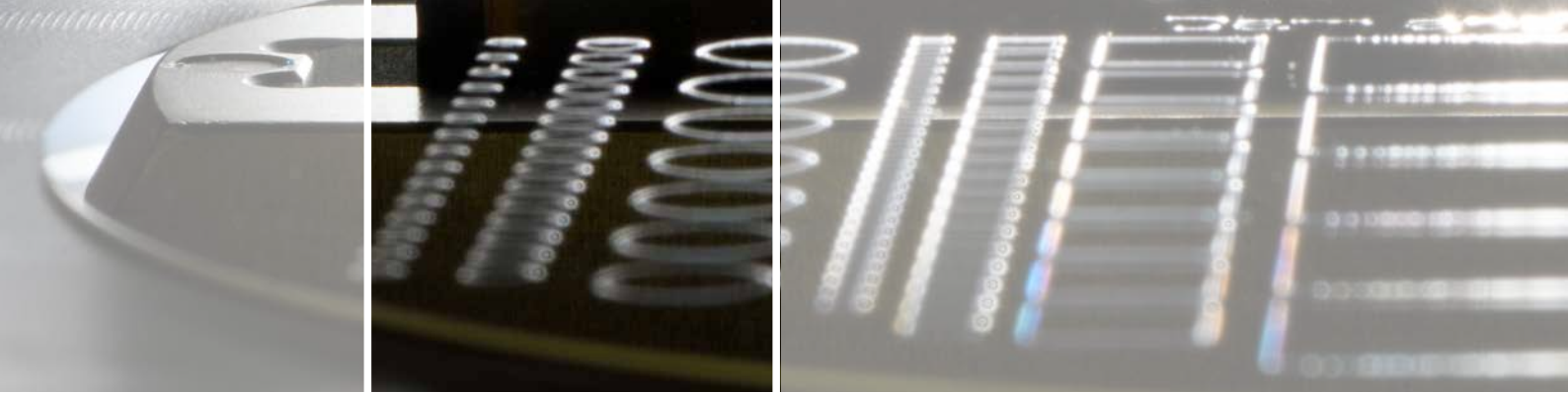
- + Advanced Drop Analysis for best jetting performance
- + Automated Print Optimization for best print settings

Variety of options

- + Integrated UV curing
- + Chuck heating and cooling
- + Ink heating and recirculation
- + Dual ink supply
- + Customized substrate holders

Exchangeable Printhead Module

- + Fast and accurate printhead exchange
- + Quick change between inks



VARIETY OF ENHANCEMENTS

VERSATILITY ENABLING MANY APPLICATIONS

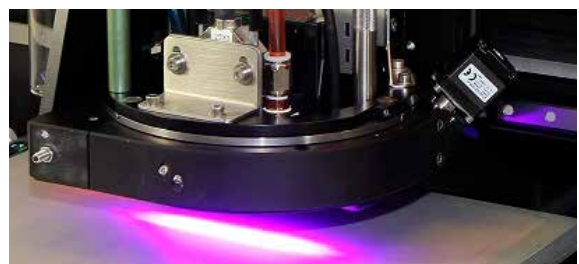
ADVANCED METROLOGY SOFTWARE

Automated software applications save significant research time and yield highest quality. The Advanced Drop Analysis (ADA) feature enables fully automated multi-dimensional research of ink drop formation for best ink jetting performance. Automated Print Optimization (APO) unlocks the full potential of the printer by providing fast access to optimal print settings for best application results.



A WIDE SELECTION OF PRINTHEADS

SUMMARY OF PRINTHEADS			
	Printhead Type	Nozzles [#]	Drop Size [pL]
Fujifilm Dimatrix	S - Class	128	30 - 80
	Q - Class	256	10 - 80
	Samba G3L	2048	2.4
Konica Minolta	KM512	512	4 - 40
	KM1024i	1024	6 - 30
Xaar	1003	1000	1 - 40
Canon	C29	256	29



KONICA MINOLTA PRINTHEADS WITH INLINE UV CURING MODULE

Precise printing and curing in one movement.



SAMBA G3L PRINTHEAD AND RECIRCULATION MODULE

Most advanced functional inkjet technology for extremely precise and fast printing.



XAAR PRINTHEAD AND RECIRCULATION MODULE

Especially designed for printing inks that exhibit sedimentation behavior and need a recirculating ink supply.



CANON HOTMELT PRINTHEAD

Fast and precise printing of hotmelt inks suited for etching and plating masking applications.



PIXDRO LP50

TECHNICAL DATA

GENERAL INFORMATION	
Max. Substrate Size	227 x 327 mm
Max. Substrate Thickness	25 mm
Substrate Chuck	Vacuum clamping
Substrate Temperature Control	Heating up to 90°C (optional cooling down to 4°C)
Stage Accuracy	± 15 µm (3σ)
Stage Precision	± 5 µm (3σ)
Motion	X, Y, Z Rotation of substrate table and printhead
Print Speed	Up to 500 mm/s
Printheads	12–2,048 nozzles; 2.4–80 pL drop size
Printhead Exchange Time	< 2 minutes, kinematic calibration
Printhead Maintenance	Purging, spitting, capping, wiping
Vision Systems	Drop view and print image view
Operation	Intuitive HMI; open source recipe scripting
Image Formats	Bitmap, postscript, PDF
Ink Types	Solvent based, nanoparticle, aqueous, hotmelt, UV-curable
Ink Viscosity	2–20 cP
Ink Supply	Header tank, typically 15 mL
Advanced Drop Analysis (Option)	Automatic calculation of drop volume, speed and angle
Automated Print Optimization (Option)	Test print patterns to determine best process parameters
Intergrated Post Processing (Option)	UV pinning or curing
Footprint (W x D x H)	Approx. 770x620x410 (excl. PC and monitor)
Weight	Approx. 90kg

ADVANCED PRINTING CONTROL	
Open software for setting print parameters	Print simulator Pulse shape, voltage and length Ink and substrate temperature Resolution (dpi) Swath and drop sequencing Nozzle offset compensation Individual nozzle allocation Bitmap oversampling Meniscus pressure Jetting frequency

SOPHISTICATED HUMAN INTERFACE	
Intuitive User Access	Print parameter settings Process recipes Camera views Motion control
Work Flow Sequencing	Combine recipes and printing settings Repetitive printing at different positions Automatic inspection of print result Automatic printhead maintenance

Data, design and specification depend on individual process conditions and can vary according to equipment configurations. Not all specifications may be valid simultaneously. Illustrations, photos and specifications in this brochure are not legally binding. SUSS MicroTec reserves the right to change machine specifications without prior notice.

NORTH AMERICA

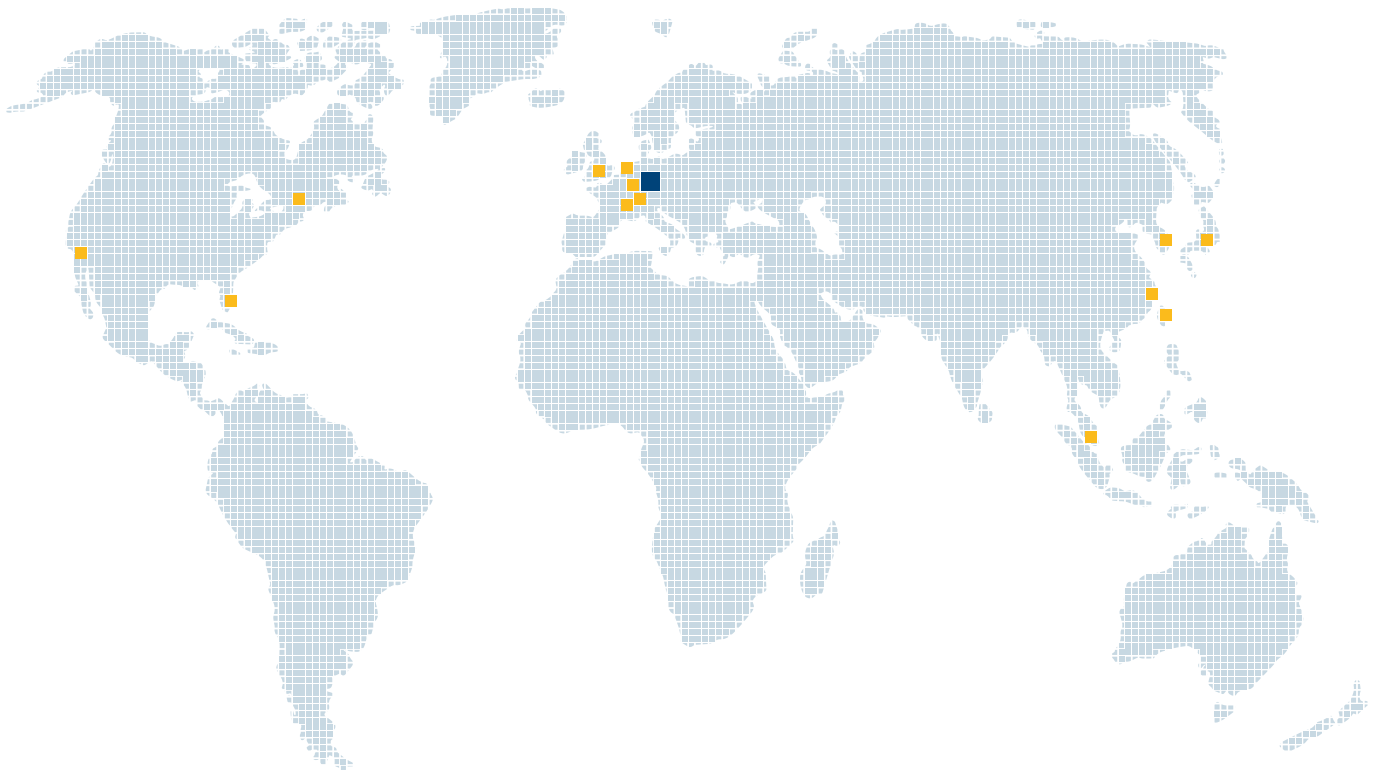
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